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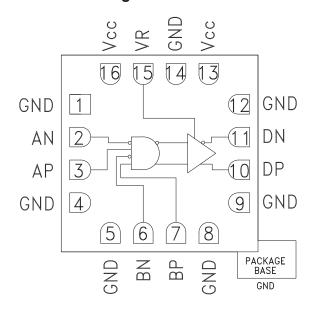
# 13 Gbps, FAST RISE TIME AND/NAND/OR/NOR GATE, w/ PROGRAMMABLE OUTPUT VOLTAGE & POSITIVE SUPPLY

### Typical Applications

The HMC746LC3C is ideal for:

- RF ATE Applications
- Broadband Test & Measurement
- Serial Data Transmission up to 14 Gbps
- Digital Logic Systems up to 14 GHz
- NRZ-to-RZ Conversion

### **Functional Diagram**



#### **Features**

Supports High Data Rates: up to 14 Gbps Differential & Single-Ended Operation Fast Rise and Fall Times: 22 / 21 ps Low Power Consumption: 230 mW typ.

Programmable Differential

Output Voltage Swing: 600 - 1100 mV

Propagation Delay: 95 ps Single Supply: +3.3 V

16 Lead Ceramic 3x3 mm SMT Package: 9 mm²

### **General Description**

The HMC746LC3C is an AND/NAND/OR/NOR function designed to support data transmission rates of up to 14 Gbps, and clock frequencies as high as 14 GHz. The HMC746LC3C may be easily configured to provide any of the following logic functions: AND, NAND, OR and NOR.

All differential inputs to the HMC746LC3C are CML and terminated on-chip with 50 Ohms to the positive supply, Vcc, and may be AC or DC coupled. The differential CML outputs are source terminated to 50 Ohms and may also be AC or DC coupled. Outputs can be connected directly to a 50 Ohm Vcc-terminated system, while DC blocking capacitors may be used if the terminating system is 50 Ohms to ground. The HMC746LC3C also features an output level control pin, VR, which allows for loss compensation or signal-level optimazation. the HMC746LC3C operates from a single 3.3 V supply and is available in ROHS-compliant 3x3 mm SMT package.

### Electrical Specifications, $T_A = +25$ °C, Vcc = 3.3 V

Parameter	Conditions	Min.	Тур.	Max	Units
Power Supply Voltage		3.0	3.3	3.6	V
Power Supply Current			70		mA
Maximum Data Rate			14		Gbps
Maximum Clock Rate			14		GHz
Input Voltage Range		Vcc - 1.5		Vcc + 0.5	V
Input Differential Range		0.1		2	Vp-p
Input Return Loss	Frequency <14 GHz		10		dB
Output Amplitude	Single-Ended, peak-to-peak		550		mVp-p
	Differential, peak-to-peak		1100		mVp-p

## **HMC746\* PRODUCT PAGE QUICK LINKS**

Last Content Update: 02/23/2017

### COMPARABLE PARTS -

View a parametric search of comparable parts.

### **EVALUATION KITS**

HMC746LC3C Evaluation Board

### **DOCUMENTATION**

#### **Data Sheet**

• HMC746 Data Sheet

### **TOOLS AND SIMULATIONS**

HMC746 IBIS Model

## REFERENCE MATERIALS -

#### **Quality Documentation**

- Package/Assembly Qualification Test Report: LC3, LC3B, LC3C (QTR: 2014-00376 REV: 01)
- Semiconductor Qualification Test Report: BiCMOS-C (QTR: 2013-00241)

#### **Technical Articles**

• A New 13 Gbps/13 GHz +3.3V High Speed Logic Family

## DESIGN RESOURCES 🖵

- HMC746 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- Symbols and Footprints

### **DISCUSSIONS**

View all HMC746 EngineerZone Discussions.

### SAMPLE AND BUY 🖵

Visit the product page to see pricing options.

### **TECHNICAL SUPPORT**

Submit a technical question or find your regional support number.

### DOCUMENT FEEDBACK 🖳

Submit feedback for this data sheet.



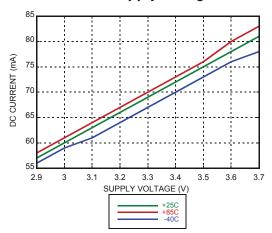


### **Electrical Specifications** (continued)

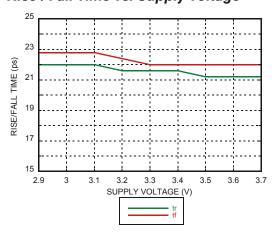
Parameter	Conditions	Min.	Тур.	Max	Units
Output High Voltage			3.29		V
Output Low Voltage			2.74		V
Output Rise / Fall Time	Differential, 20% - 80%		22 / 21		ps
Output Return Loss	Frequency <13 GHz		10		dB
Small Signal Gain			27		dB
Random Jitter Jr	rms			0.2	ps rms
Deterministic Jitter, Jd	peak-to-peak, 2 <sup>15</sup> -1 PRBS input <sup>[1]</sup>		2		ps, p-p
Propagation Delay, td			95		ps
VR Pin Current	VR = 3.3 V		2		mA
VR Pin Current	VR = 3.7 V			3.5	mA

<sup>[1]</sup> Deterministic jitter calculated by simultaneously measuring the jitter of a 300 mV, 13 GHz, 215-1 PRBS input, and a single-ended output

### DC Current vs. Supply Voltage [1][2]



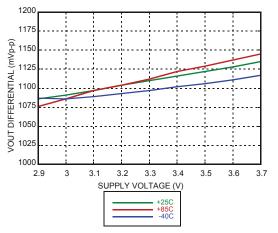
#### Rise / Fall Time vs. Supply Voltage [1][2]



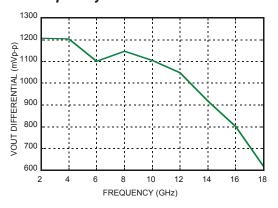
[1] VR = 3.3 V [2] Frequency = 13 GHz

[3] Vcc = 3.3 V

# Output Differential Voltage vs. Supply Voltage [1][2]



## Output Differential Voltage vs. Frequency [1][3]

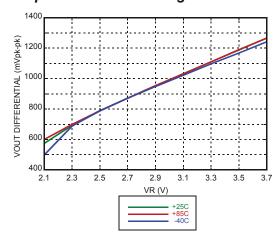


For price, delivery, and to place orders: Analog Devices, Inc., One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106 Phone: 781-329-4700 • Order online at www.analog.com Application Support: Phone: 1-800-ANALOG-D

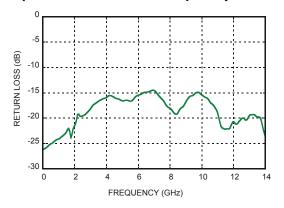




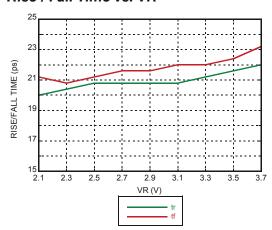
### Output Differential Voltage vs. VR [1][2]



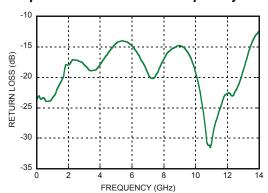
### Input Return Loss vs. Frequency



### Rise / Fall Time vs. VR [1][2]



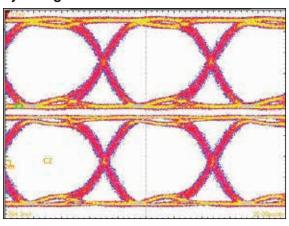
### **Output Return Loss vs. Frequency**







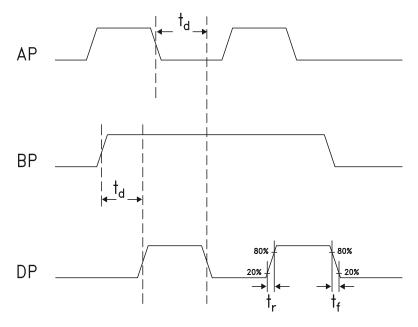
### Eye Diagram



#### [1] Test Conditions:

Pattern generated with an Agilent N4903A Serial BERT. Eye Diagram presented on a Tektronix CSA 8000. Device input = 13 Gbps PN code. Device is AC coupled to scope.

### **Timing Diagram**



#### **Truth Table**

Input		Outputs
A	В	D
L	L	L
L	Н	L
Н	L	L
Н	Н	Н
Notes: A = AP - AN B = BP - BN D = DP - DN	H - Positive voltage level L - Negative voltage level	



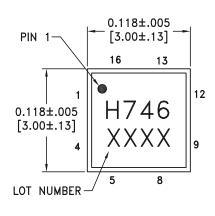


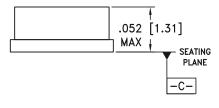
### **Absolute Maximum Ratings**

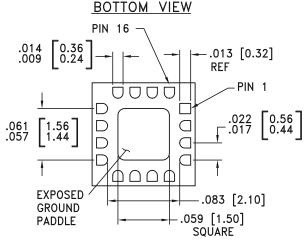
Power Supply Voltage (Vcc)	Vcc -0.5 V to 3.75 V	
Input Signals	Vcc - 2.0 V to Vcc + 0.5 V	
Output Signals	Vcc - 1.5 V to Vcc + 0.5 V	
Continuous Pdiss (T = 85 °C) (derate 17 mW/°C above 85 °C)	0.68 W	
Thermal Resistance (R <sub>th j-p</sub> ) Worst case junction to package paddle	59 °C/W	
Maximum Junction Temperature	125 °C	
Storage Temperature	-65 °C to +150 °C	
Operating Temperature	-40 °C to +85 °C	
ESD Sensitivity (HBM)	Class 1C	



### **Outline Drawing**







#### NOTES:

- 1. PACKAGE BODY MATERIAL: ALUMINA
- 2. LEAD AND GROUND PADDLE PLATING: 30-80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKEL.
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05 mm DATUM -C-
- 6. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.
- 7. PADDLE MUST BE SOLDERED TO GND.

### Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [2]
HMC746LC3C	Alumina, White	Gold over Nickel	MSL3 [1]	H746 XXXX

<sup>[1]</sup> Max peak reflow temperature of 260  $^{\circ}\text{C}$ 

<sup>[2] 4-</sup>Digit lot number XXXX





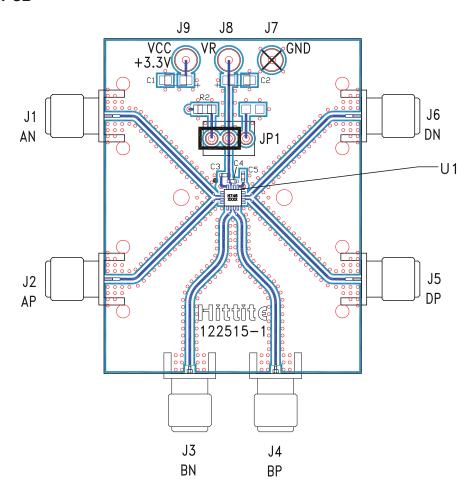
### **Pin Descriptions**

Pin Number	Function	Description	Interface Schematic
1, 4, 5, 8, 9, 12	GND	Signal Grounds	⊖ GND =
2, 3 6, 7	AN, AP BN, BP	Differential Data Inputs: Current Mode Logic (CML) referenced to positive supply.	GND O HOO GND
10, 11	DP, DN	Differential Data Outputs: Current Mode Logic (CML) referenced to positive supply.	GND O O DN
13, 16	Vcc	Positive Supply	
14, Package Base	GND	Supply Ground	O GND
15	VR	Output level control. Output level may be adjusted by applying a voltage to VR per "Output Differential vs. VR" plot.	VR 0





#### **Evaluation PCB**



### List of Materials for Evaluation PCB 122517 [1]

Item	Description	
J1 - J6	PCB Mount SMA RF Connectors	
J7 - J9	DC Pin	
JP1	Shorting Jumper	
C1, C2	4.7 μF Capacitor, Tantalum	
C3 - C5	- C5 100 pF Capacitor, 0402 Pkg. 10 Ohm Resistor, 0603 Pkg.	
R2		
U1	HMC746LC3C High Speed Logic, AND / NAND / OR / NOR	
PCB [2]	2] 122515 Evaluation Board	

<sup>[1]</sup> Reference this number when ordering complete evaluation PCB

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. The exposed package base should be connected to GND. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request. Install jumper on JP1 to short VR to Vcc for normal operation.

<sup>[2]</sup> Circuit Board Material: Arlon 25FR or Rogers 4350

HIGH SPEED LOGIC - SMT





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### **Application Circuit**

